# Plastic Medium-Power Complementary Silicon Transistors

These devices are designed for general-purpose amplifier and low-speed switching applications.

## Features

- High DC Current Gain
  - $h_{FE} = 2500 \text{ (Typ)} @ I_C = 4.0 \text{ Adc}$
- Collector Emitter Sustaining Voltage @ 100 mAdc
  V<sub>CEO(sus)</sub> = 80 Vdc (Min) BDX53B, 54B = 100 Vdc (Min) – BDX53C, 54C
- Low Collector–Emitter Saturation Voltage
  - $V_{CE(sat)} = 2.0 \text{ Vdc (Max)} @ I_C = 3.0 \text{ Adc}$  $= 4.0 \text{ Vdc (Max)} @ I_C = 5.0 \text{ Adc}$
- Monolithic Construction with Built-In Base-Emitter Shunt Resistors
- These Devices are Pb-Free and are RoHS Compliant\*

## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage BDX53B, BDX54B BDX53C, BDX54C	V <sub>CEO</sub>	80 100	Vdc
Collector–Base Voltage BDX53B, BDX54B BDX53C, BDX54C	V <sub>CB</sub>	80 100	Vdc
Emitter–Base Voltage	V <sub>EB</sub>	5.0	Vdc
Collector Current – Continuous – Peak	Ι <sub>C</sub>	8.0 12	Adc
Base Current	Ι <sub>Β</sub>	0.2	Adc
Total Device Dissipation @ $T_C = 25^{\circ}C$ Derate above $25^{\circ}C$	PD	65 0.48	W ₩/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	70	°C/W
Thermal Resistance, Junction-to-Case	$R_{\thetaJC}$	1.92	°C/W

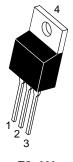
\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



# **ON Semiconductor®**

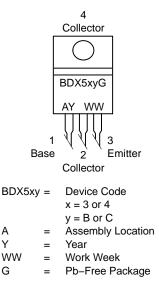
www.onsemi.com

DARLINGTON 8 AMPERE COMPLEMENTARY SILICON POWER TRANSISTORS 80–100 VOLTS, 65 WATTS



TO-220 CASE 221A STYLE 1

## MARKING DIAGRAM & PIN ASSIGNMENT



#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

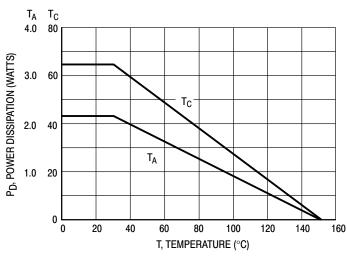


Figure 1. Power Derating

## ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS			•	•	
Collector–Emitter Sustaining Voltage (Note 1) ( $I_C = 100$ mAdc, $I_B = 0$ )	BDX53B, BDX54B BDX53C, BDX54C	V <sub>CEO(sus)</sub>	80 100		Vdc
Collector Cutoff Current $(V_{CE} = 40 \text{ Vdc}, I_B = 0)$ $(V_{CE} = 50 \text{ Vdc}, I_B = 0)$	BDX53B, BDX54B BDX53C, BDX54C	I <sub>CEO</sub>		0.5 0.5	mAdc
Collector Cutoff Current $(V_{CB} = 80 \text{ Vdc}, I_E = 0)$ $(V_{CB} = 100 \text{ Vdc}, I_E = 0)$	BDX53B, BDX54B BDX53C, BDX54C	I <sub>CBO</sub>		0.2 0.2	mAdc
ON CHARACTERISTICS (Note 1)					
DC Current Gain (I <sub>C</sub> = 3.0 Adc, V <sub>CE</sub> = 3.0 Vdc)		h <sub>FE</sub>	750	-	-
Collector–Emitter Saturation Voltage $(I_C = 3.0 \text{ Adc}, I_B = 12 \text{ mAdc})$		V <sub>CE(sat)</sub>		2.0 4.0	Vdc
Base–Emitter Saturation Voltage ( $I_C = 3.0 \text{ Adc}, I_C = 12 \text{ mA}$ )		V <sub>BE(sat)</sub>	_	2.5	Vdc
DYNAMIC CHARACTERISTICS					
Small–Signal Current Gain		hea	4.0	_	_

Small–Signal Current Gain (I <sub>C</sub> = 3.0 Adc, V <sub>CE</sub> = 4.0 Vdc, f = 1.0 MHz)		h <sub>fe</sub>	4.0	-	-
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 0.1 MHz)	BDX53B, 53C BDX54B, 54C	C <sub>ob</sub>		300 200	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2%.

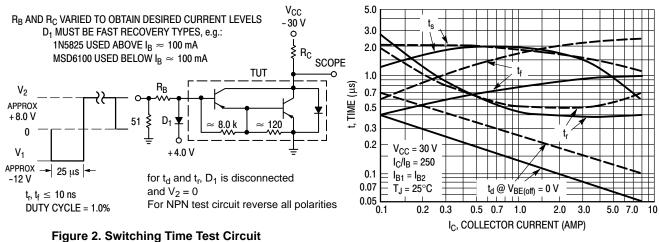
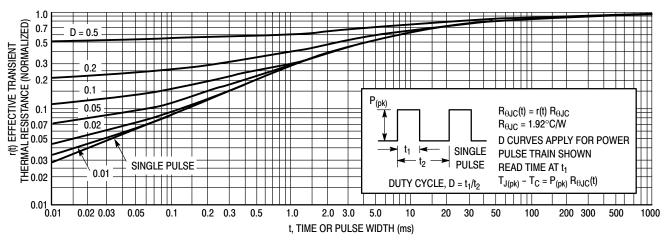


Figure 3. Switching Times



**Figure 4. Thermal Response** 

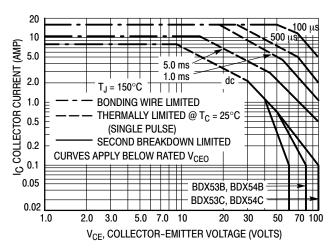


Figure 5. Active–Region Safe Operating Area

There are two limitations on the power handling ability of a transistor average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on  $T_{J(pk)} = 150^{\circ}$ C;  $T_{C}$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} < 150^{\circ}$ C.  $T_{J(pk)}$  may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

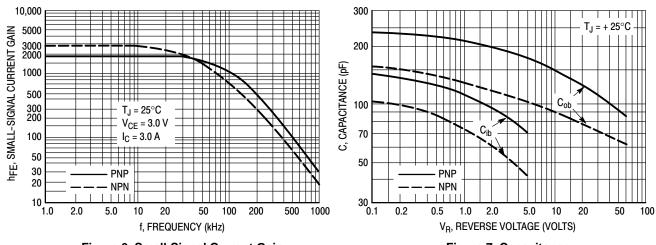


Figure 6. Small-Signal Current Gain

Figure 7. Capacitance

NPN BDX53B, 53C

PNP BDX54B, 54C

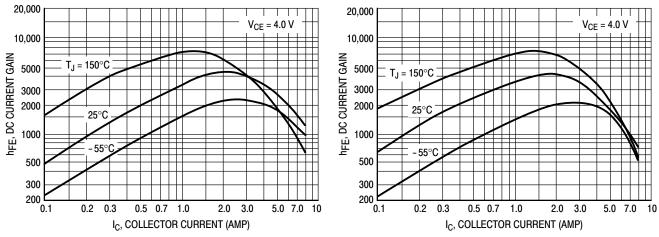
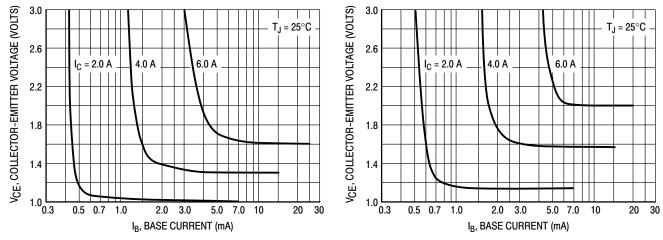
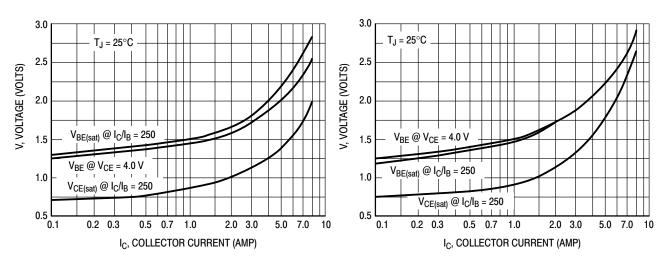
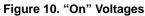


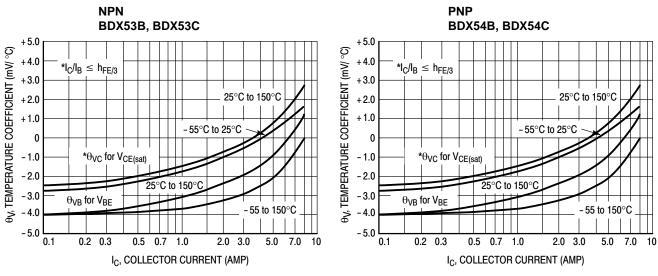
Figure 8. DC Current Gain

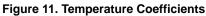


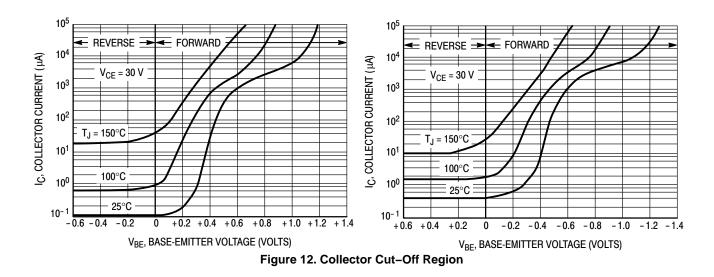


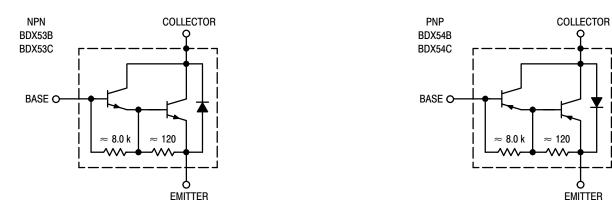














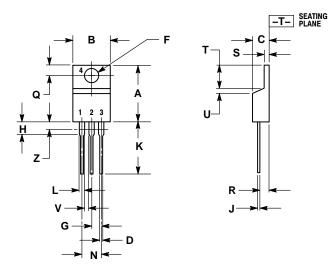
#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
BDX53BG	TO-220 (Pb-Free)	50 Units / Rail
BDX53CG	TO-220 (Pb-Free)	50 Units / Rail
BDX54BG	TO-220 (Pb-Free)	50 Units / Rail
BDX54CG	TO-220 (Pb-Free)	50 Units / Rail

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH** 



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED

	INCHES		MILLIN	IILLIMETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.415	9.66	10.53	
С	0.160	0.190	4.07	4.83	
D	0.025	0.038	0.64	0.96	
F	0.142	0.161	3.61	4.09	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.161	2.80	4.10	
ſ	0.014	0.024	0.36	0.61	
κ	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
Ν	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
۷	0.045		1.15		
Ζ		0.080		2.04	

STYLE 1: BASE PIN 1. 2. COLLECTOR FMITTER 3 COLLECTOR 4.

ON Semiconductor and the 💷 are registered trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries. SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other industries, Ltc (SoLLC product) of its substants in the United States and/or other Countries. SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other industries, Ltc (SoLLC) of its substants in the United States and/or other Countries. SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other industries, Ltc (SoLLC) of its substants in the United States and/or other Countries. SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other industries, Ltc (SoLLC) of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights or other, sustain life, or for any data and other survival or authorized for use a component is number to survival into the body or other applications. or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor: BDX53BG BDX53CG BDX54BG BDX54CG